

Description

The EL3H7 is a photielectric couoler composed of light-emitting diode and phototransistor.It is packaged in a 4-pin package.

Features

- Current transfer radio(CTR:MIN.50% at IF=5mA,VCE=5V)
- High input-output isolation voltage (Viso=3,750Vrms)
- Operating Temperature:-55°C~100°C
- RoHS

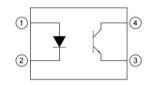
Applications

- Programmable controllers
- Switching power supply,intelligent meter
- Home appliances: such as air conditioners, fans,water heaters,etc



SSOP-4

Schematic



- Pin Configuration
- 1 Anode
- 2 Cathode
- 3 Emitter
- 4 Collector

Absolute Ratings(Tamb = 25°C)

	Parameter	Symbol	Values	Unit
	Forward Current	l _F	50	mA
Input	Reverse Voltage	V_{R}	6	V
	Power Dissipation		70	mW
	Derating factor (above Ta = 90°C)	P_D	2.0	mW/°C
Output	Collector - Emitter Voltage	$V_{\sf CEO}$	80	V
	Emitter - Collector Voltage	$V_{\sf ECO}$	7	V
	Collector Current	lc	50	mA
	Collector Power Dissipation		150	mW
	Derating factor (above Ta = 70°C)	Pc	3.1	mW/°C
Operating temperature range		T_{op}	− 55 ~ 110	°C
Storage temperature range		T _{stg}	− 55 ~ 125	°C
Total Power consumption		P(W)	200	mW
Isolation Voltage ⁽¹⁾		V _{ISO}	3750	Vrms
Soldering Temperature ⁽²⁾		T _{SOL}	260	°C

Notes

(2).For 10 seconds

^{(1).} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.



Electrical Characteristics (Ratings at 25°C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	Conditon
Input	Forward Voltage	V _F	-	1.2	1.4	V	I _F =20mA
	Reverse Current	I _R	-	-	10	μA	V _R =4V
	Terminal Capacitance	Ct	-	30	250	pF	V=0, f=1KHz
	Collector Dark Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0
Output	Collector-Emitter Breakdown Voltage	BV _{CEO}	80			V	IC=0.1mA, IF=0
	Emitter-Collector Breakdown Voltage	BV _{ECO}	7			V	IE=10μA, IF=0
Collector-Emitter Saturation Voltage		V _{CE(sat)}		0.1	0.2	V	IF=20mA, IC=1mA
Isolation Resistance		R _{iso}	5×10 ¹⁰	1×10 ¹¹	-	Ω	DC500V, 40 ~ 60% R.H.
Floating Capacitance		Cf		0.6	1	pF	V=0, f=1MHz
Cut-off Frequency		fc		80		kHz	VCE=5V, IC=2mA RL=100Ω,-3d B
Response Time (Rise)		tr		4	18	μs	VCE=2V, IC=2mA
Response Time (Fall)		tf		3	18	μs	RL=100Ω,

Rank Table Of Current Transfer Ratio (CTR=IC/IF x100%)

Rank Code	Symbol	Min	Max	Conditon
NONE		50	600	
Α	CTR	80	160	IF=5mA,
В		130	260	VCE=5V, Ta=25°C
С		200	400	1a=25°C
D		300	600	



Characteristics Curves

Fig.1 Relative Current Transfer Ratio vs. Forward Current

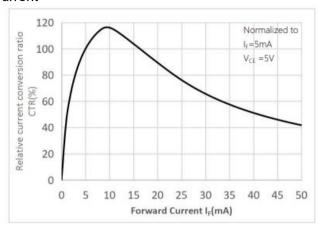


Fig.2 Forward Current vs. Forward Voltage

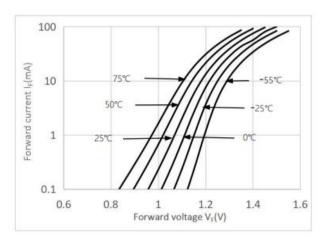


Fig.3 Collector Current vs. Collector-emitter Voltage

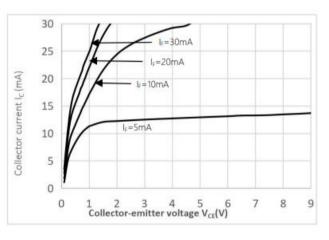


Fig.4 Relative Current Transfer Ratio vs.Ambient Temperature

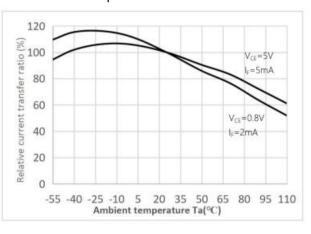


Fig.5 Collector-emitter Saturation Voltage vs. Ambient Temperature

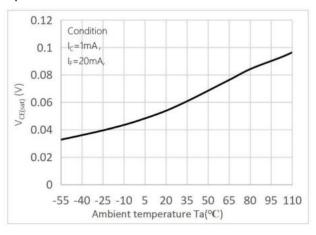


Fig.6 Collector Dark Current vs Ambient Temperature

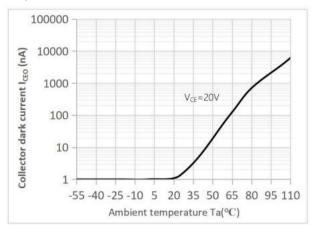




Fig.7 Response Time vs. Load Resistance

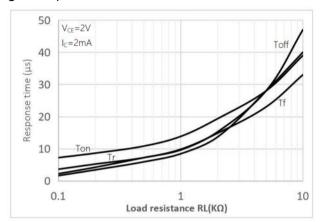


Fig.9 Collector-emitter Saturation Voltage vs Forward Current

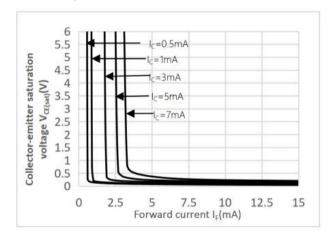


Fig.8 Frequency Response

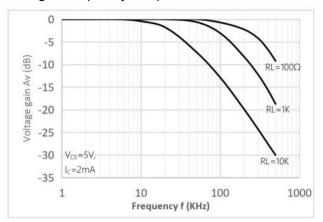
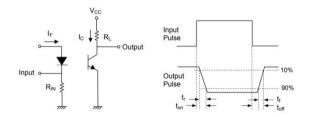
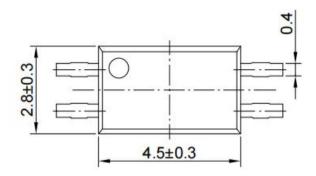
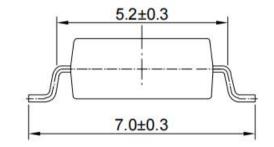


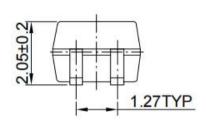
Fig.10 Switching Time Test Circuit & Waveforms



Outline Dimension



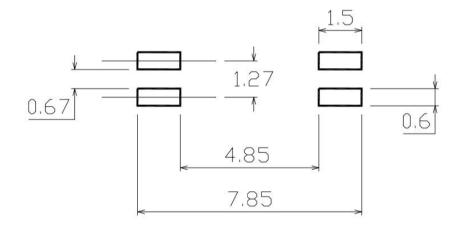




Unit: mm

Tolerance: ±0.1mm

Recommended solder pad Design



Unit: mm

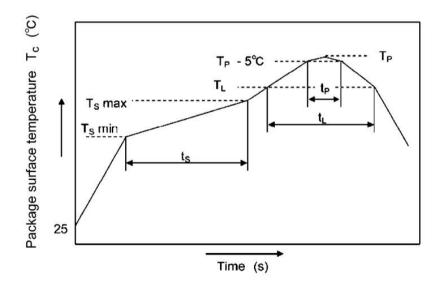
Tolerance: ±0.1mm



Temperature Profile Of Soldering

1.IR Reflow soldering (JEDEC-STD-020D compliant)

Profile item	Conditon
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts)	150°C 200°C 90±30 sec
Soldering zone -Temperature (TL) -Time (tL) Peak Temperature (TP)	217°C 60-150 sec 260°C
-Time (TP-5°C to TP) (ts) Ramp-up rate Ramp-down rate	30 sec 3°C / sec max 3~6°C/ sec



Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



2. Wave soldering (JEDEC22A111 compliant)

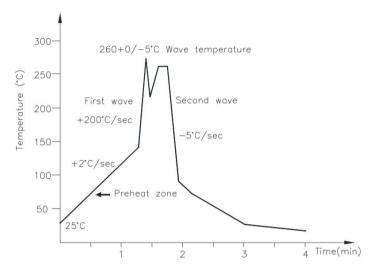
One time soldering is recommended within the condition.

Temperature:260+0/-5°C.

Time:10 sec.

Preheat temperature:25 to 140°C.

Preheat time:30 to 80 sec.

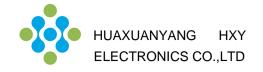


3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.



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